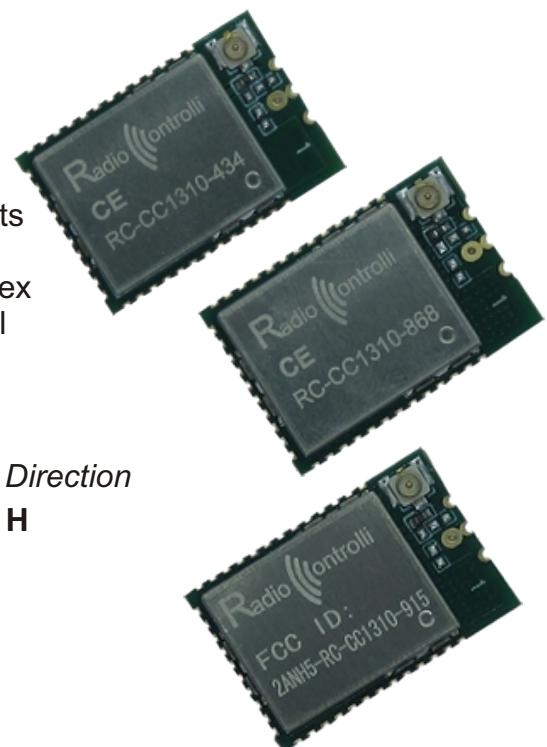


## Ultra Low Power sub 1GHz Multichannels Radio Transceiver

The **RC-CC1310-XXX** module is based on Texas Instruments CC1310F128 component. This device combines a flexible, very low power RF transceiver with a powerful 48 MHz Cortex M3 microcontroller in a platform supporting multiple physical layers and RF standard.

Module Information :

	Frequency	Antenna Direction
RC-CC1310 - XXX	<b>434=434MHz</b>	- H
	<b>868=868MHz</b>	
	<b>915=915MHz</b>	



Sub-1Ghz technology is becoming one of the chief driving forces behind the **Internet of Things (IoT)**, in particular this type of module is ideal for this applications basically for the following reasons :

**Ultra low power consumption**, the consumption of this device is 5.5mA when receiving and 23.5mA when transmitting at +14dBm (13.4mA at +10dBm) in sleep mode the consumption is 0.6µA (microamps).

**Long range operations**, the sensitivity parameter is -110dBm at data rates of 50 kbps and down to -124dBm when the data rate is 0.625kbps.

Interference from other wireless communications can be overcome with 90dB of blocking.

The RF output power levels can reach up to +14dBm.

All this ensure a robust signaling for long range communications.

**SimpleLink-Easylink** compatibility, ultra-low power platform designed (from TI) to easily implement the long-range connectivity with low power consumption on the Internet of Things projects (IoT).

**TI-15.4 Stack**, IEEE802.15.4e/g Standard Based Star Networking Software Designed for long range & robust star networks.

**6LoWPAN** compatibility with mesh network stack for **Contiki**.

### Applications :

- Low-Power Wireless Systems
- Smart Grid and Automatic Meter Reading
- Home and Building Automation
- Wireless Sensor Network
- 6LoWPAN systems

### Feature :

- IEEE 802.15.4g mode switch support
- Ultra Low consumption technology
- Powerful ARM Cortex M3
- Supported by the open platform Contiki 6LoWPAN.
- Very Small size

RC-CC1310-XXX					
Parameter	Symbol	Min.	Typ.	Max.	Units
Operating Voltage	$V_{CC}$	1.8	3.00	3.8	VDC
Supply Current RX Mode	$I_{CRX}$		5.50		mA
Supply Current TX Mode +10dBm	$I_{CTX1}$		13.40		mA
Supply Current TX Mode +14dBm	$I_{CTX2}$		23.50		mA
Supply Current Standby Mode	$I_{CSTB}$		0,70		$\mu$ A
Supply Current Shut Down Mode	$I_{CSHU}$		185		nA
Operative Frequency	$F_{of}$	433/868/915			MHz
Frequency Error	$F_{pp}$		$\pm 10$		ppm
RF Power Output 50ohm (*)	$P_{oo}$	-10.0		+14.0	dBm
RF Sensibility 50kbps	$S_d$		-110.0		dBm
RF Sensibility Long Range Mode 625bps	$S_{LR}$		-124.0		dBm
Data Rate	$D_{CC}$	0,01		4.0	Mbit/s
Operative Temperature	$T_{LR}$	-30		+75	$^{\circ}$ C

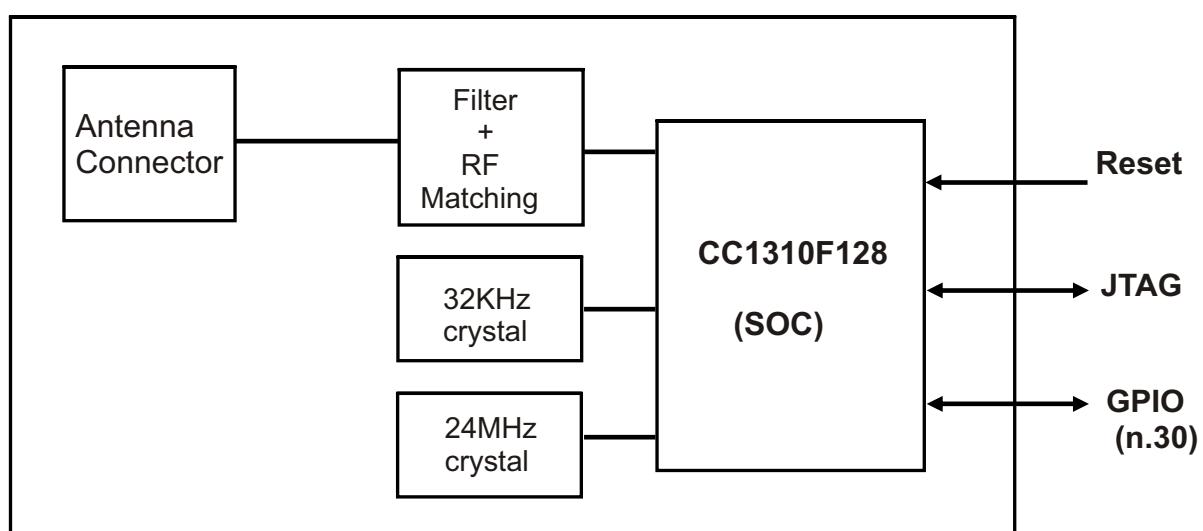
(\*) Programmable parameter.

#### MICROCONTROLLER:

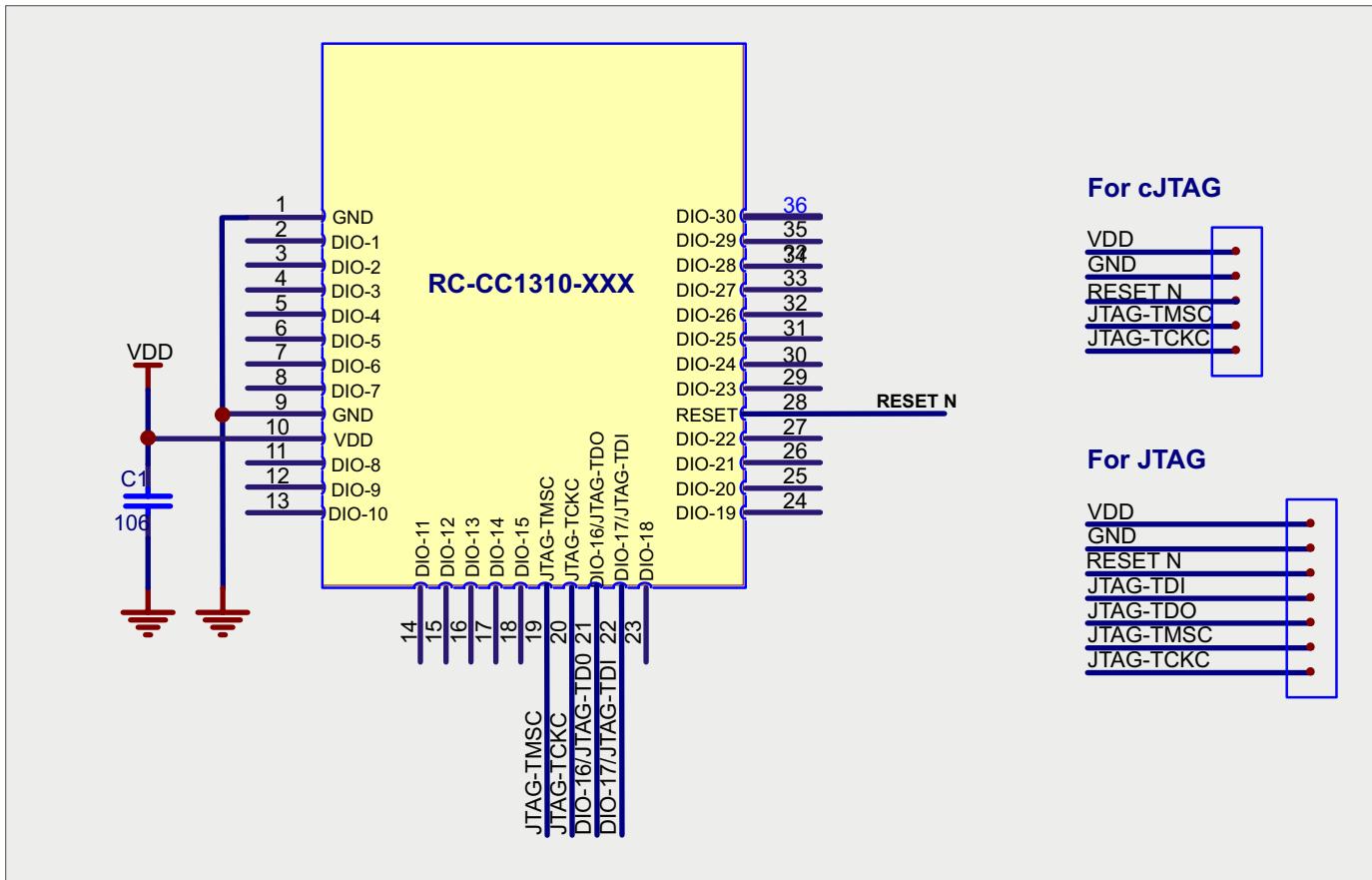
- Power ARM Cortex - M3
- Up to 48MHz Clock Speed
- 128KB of On-System Programming Flash
- 8KB of SRAM for Cache (or as General-Purpose RAM)
- 20KB of Ultralow Leakege SRAM
- Support Over-the-Air Upgrade (OTA)

For more information and details, please refer to the CC1310 Texas Instruments datasheet.

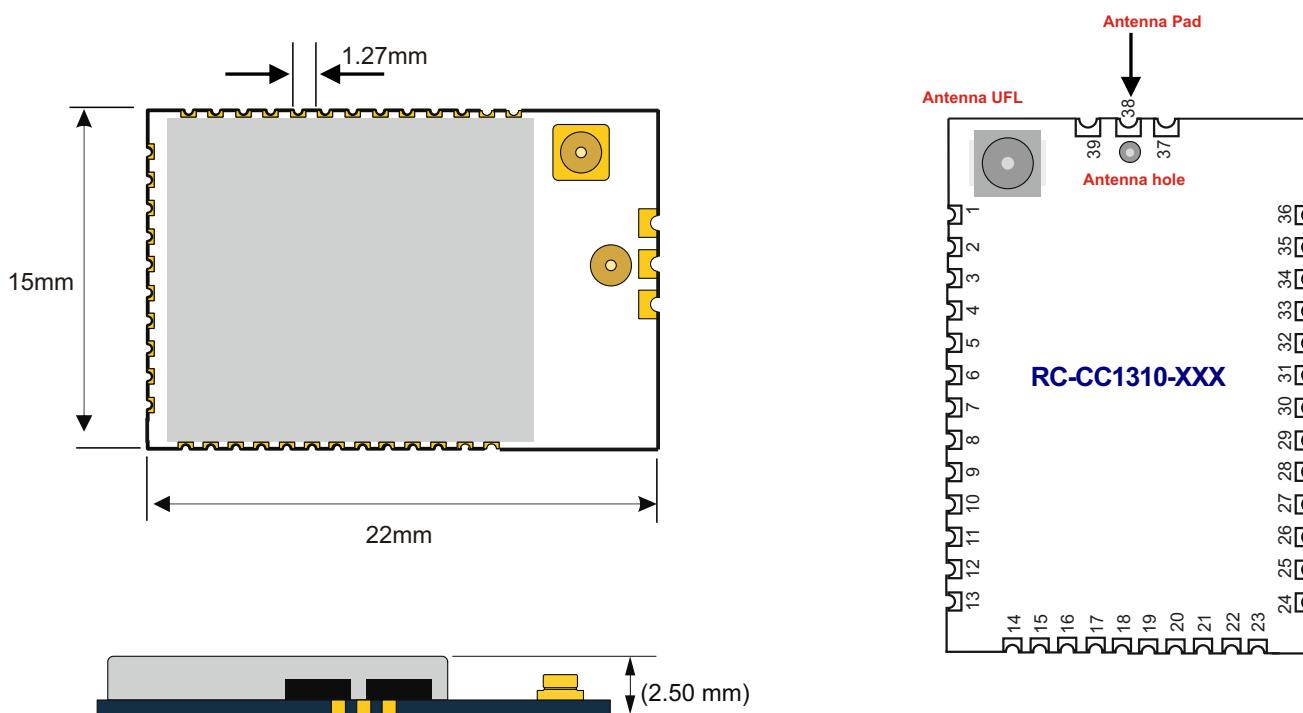
#### Block Diagram



### Reference Schematics

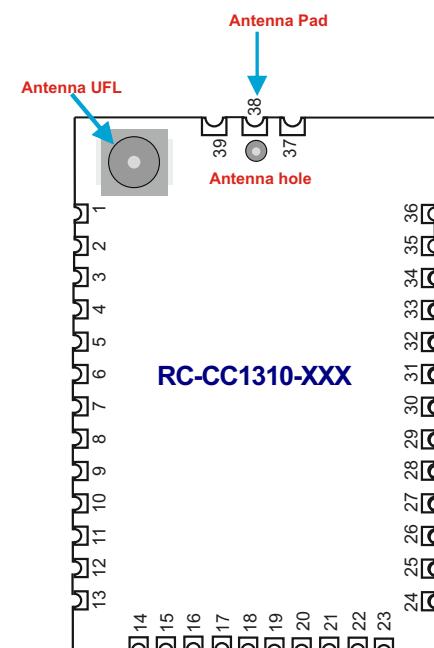


### Mechanical Dimension

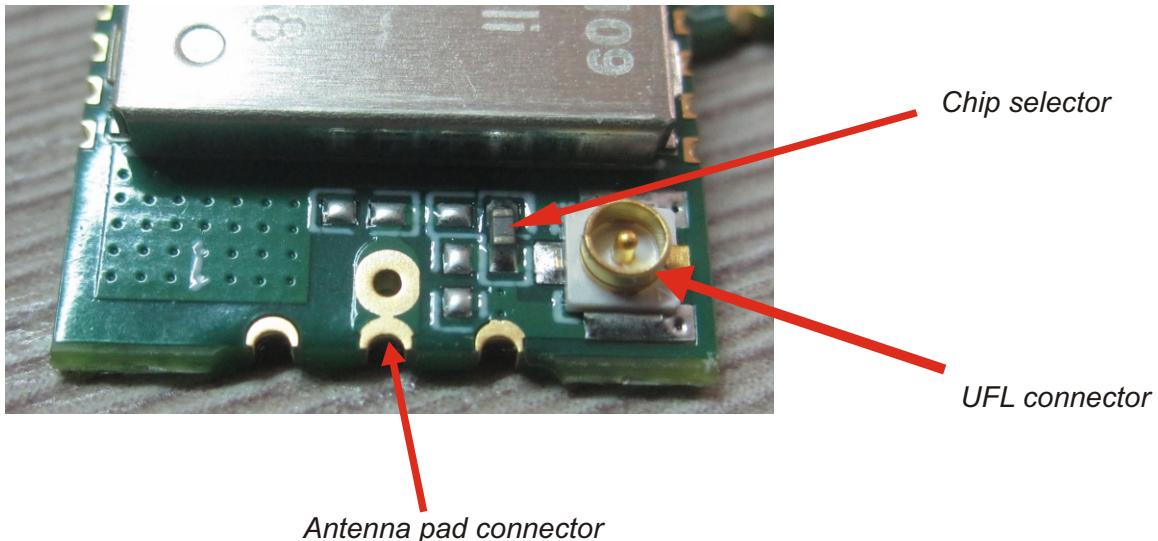


**Terminal description RC-CC1310-XXX**

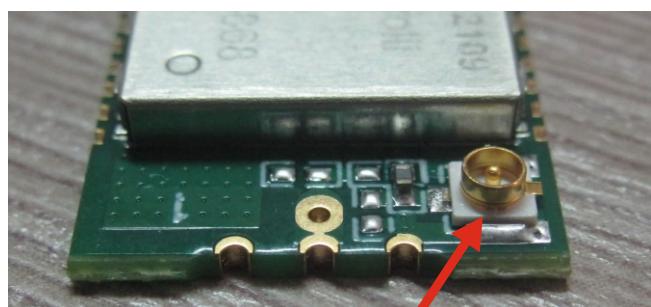
Pads	Name	Description
1	GND	Ground
2	DIO-1	GPIO, Sensor Controller, High drive capability
3	DIO-2	GPIO, Sensor Controller, High drive capability
4	DIO-3	GPIO, Sensor Controller, High drive capability
5	DIO-4	GPIO, Sensor Controller, High drive capability
6	DIO-5	GPIO, Sensor Controller, High drive capability
7	DIO-6	GPIO, Sensor Controller, High drive capability
8	DIO-7	GPIO, Sensor Controller, High drive capability
9	GND	Ground
10	VDD	Power
11	DIO-8	GPIO
12	DIO-9	GPIO
13	DIO-10	GPIO
14	DIO-11	GPIO
15	DIO-12	GPIO
16	DIO-13	GPIO
17	DIO-14	GPIO
18	DIO-15	GPIO
19	JTAG-TMSC	JTAG TMSC, High drive capability
20	JTAG-TCKC	JTAG TCKC
21	DIO-16	GPIO, JTAG -TDO, High drive capability
22	DIO-17	GPIO, JTAG-TDI, High drive capability
23	DIO-18	GPIO
24	DIO-19	GPIO
25	DIO-20	GPIO
26	DIO-21	GPIO
27	DIO-22	GPIO
28	RESET-N	RESET, (Active low)
29	DIO-23	GPIO, Sensor Controller, Analog
30	DIO-24	GPIO, Sensor Controller, Analog
31	DIO-25	GPIO, Sensor Controller, Analog
32	DIO-26	GPIO, Sensor Controller, Analog
33	DIO-27	GPIO, Sensor Controller, Analog
34	DIO-28	GPIO, Sensor Controller, Analog
35	DIO-29	GPIO, Sensor Controller, Analog
36	DIO-30	GPIO, Sensor Controller, Analog
37	GND	Ground
38	Antenna	Antenna PAD
39	GND	Ground



Type of Antenna connection

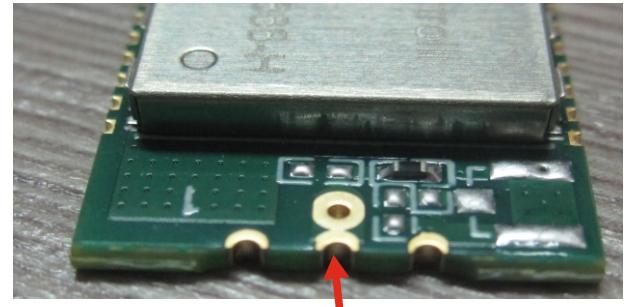


Difference between standard version and «H» version



RC-CC1310-XXX

- With UFL Connector
- Chip direct on the UFL connector



RC-CC1310-XXX-H

- Without UFL Connector
- Chip direct on pcb antenna (hole and pad)



RC-CC1310-XXX



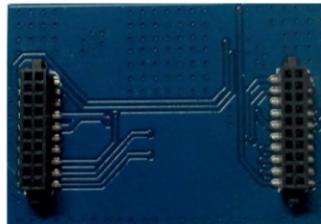
RC-CC1310-XXX-H

RC-CC1310-XXX Adapter board

To make immediate usable the RC-CC1310-XXX module with TI development systems has been realized the following board adapter.



Adapter board front



Adapter board rear

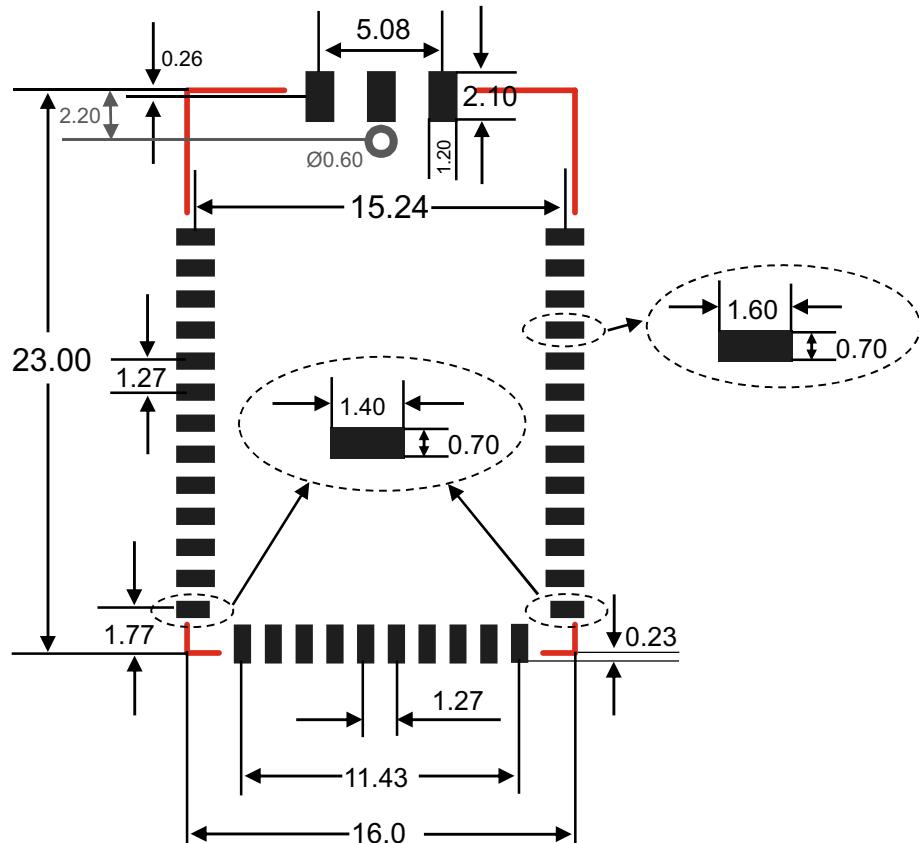


SMART RF06 Evaluation board (TI)

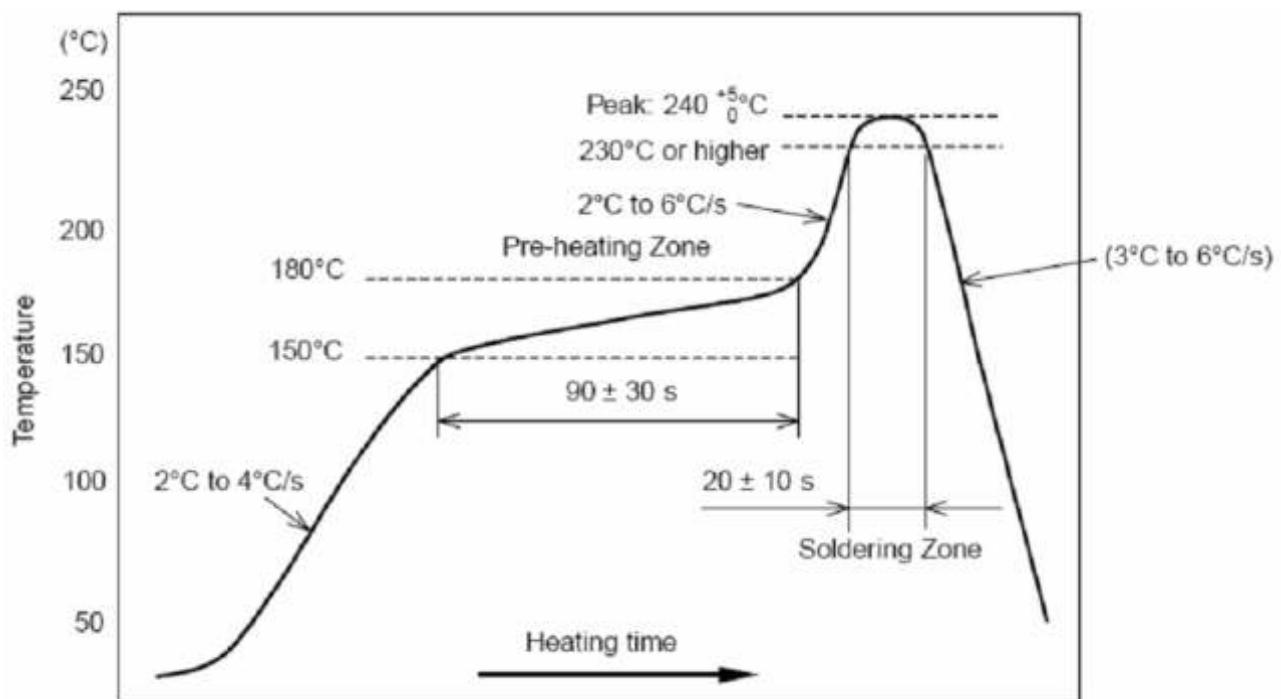


RC-CC1310-DK Evaluation kit

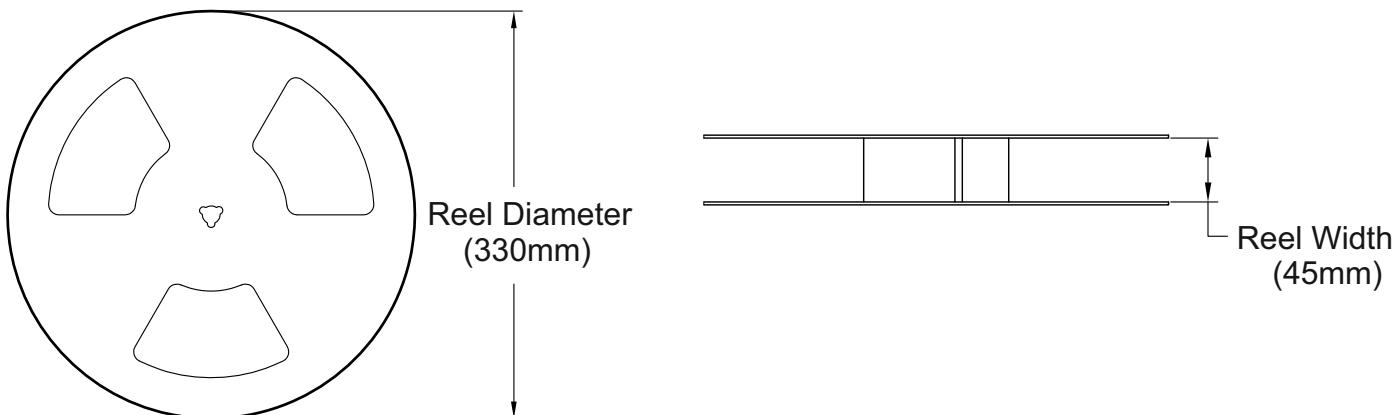
## Recommended PCB Layout



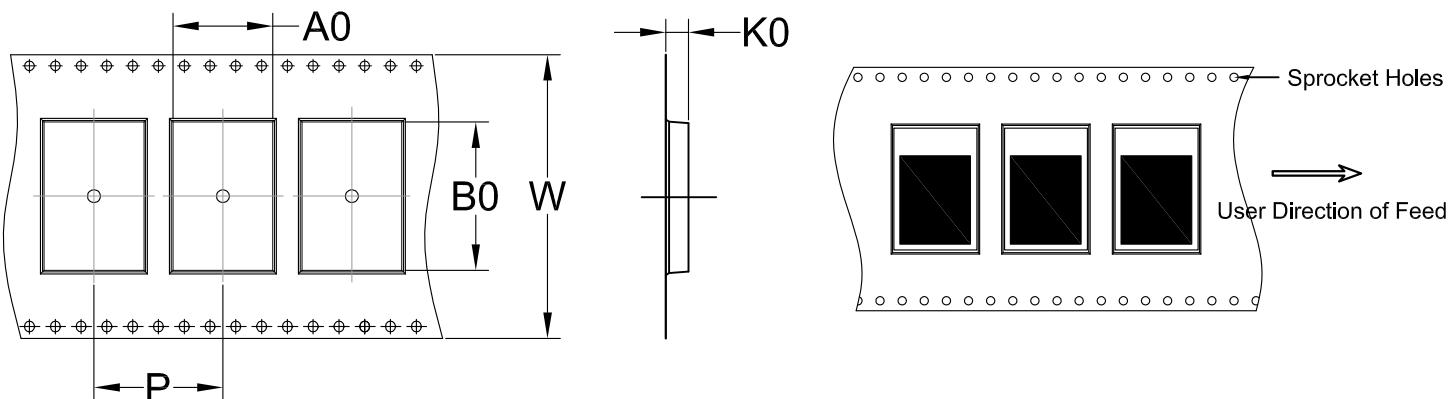
## Recommended Reflow Profile for Lead Free Solder



**REEL DIMENSIONS**



**TAPE DIMENSIONS**



A0	Dimension designed to accommodate the component width	15.5mm	$\pm 0.10\text{mm}$
B0	Dimension designed to accommodate the component length	23.0mm	$\pm 0.10\text{mm}$
K0	Dimension designed to accommodate the component thickness	3.5mm	$\pm 0.10\text{mm}$
W	Overall width of the carrier tape	44.0mm	$\pm 0.30\text{mm}$
P	Pitch between successive cavity centers	20.0mm	$\pm 0.10\text{mm}$